

Pre-Compliance Measurements according to SAE J1752-3 with ESDEMC TEM Cells

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EXPERT ESD/EMC SOLUTIONS

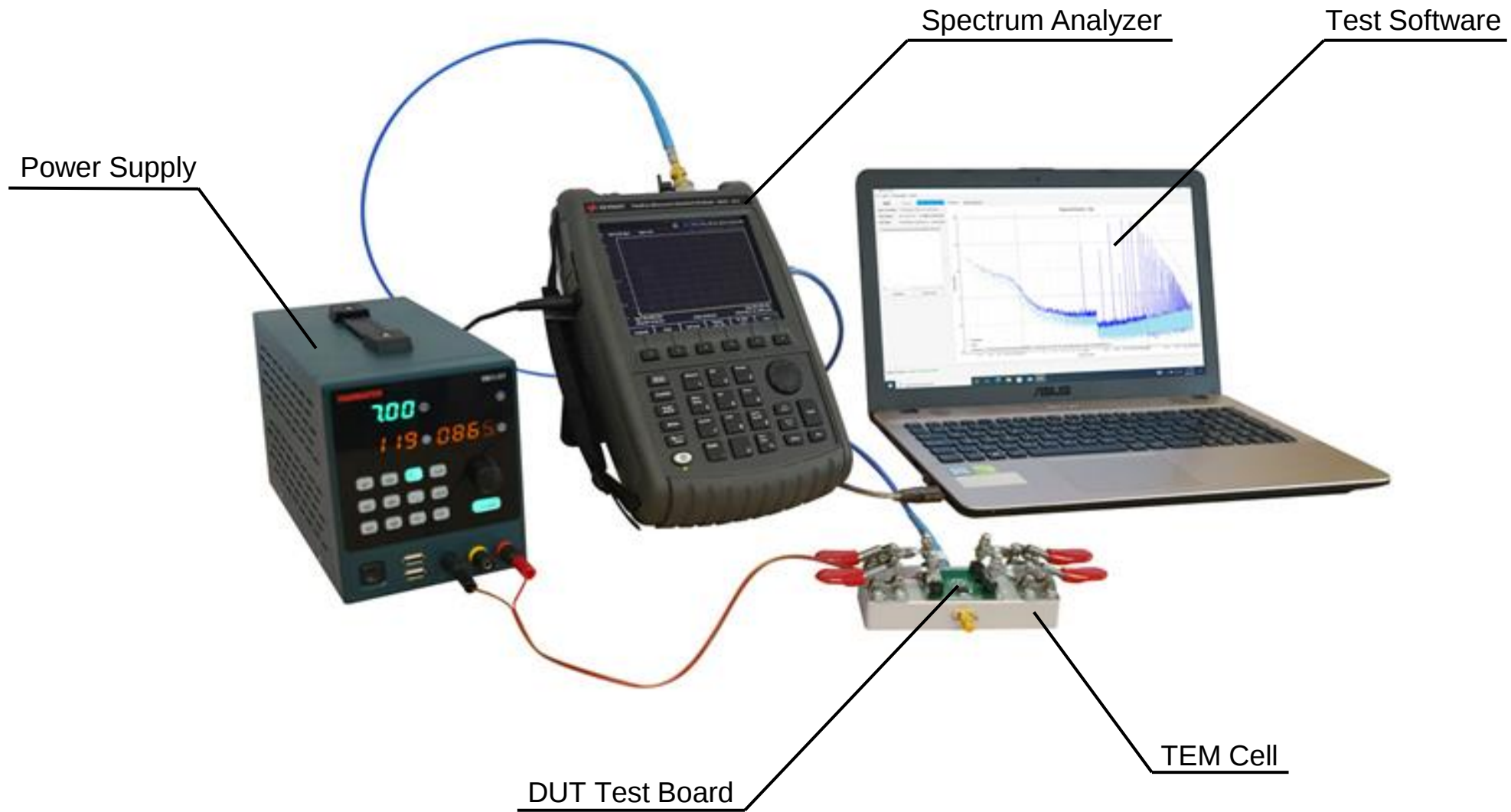
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Background

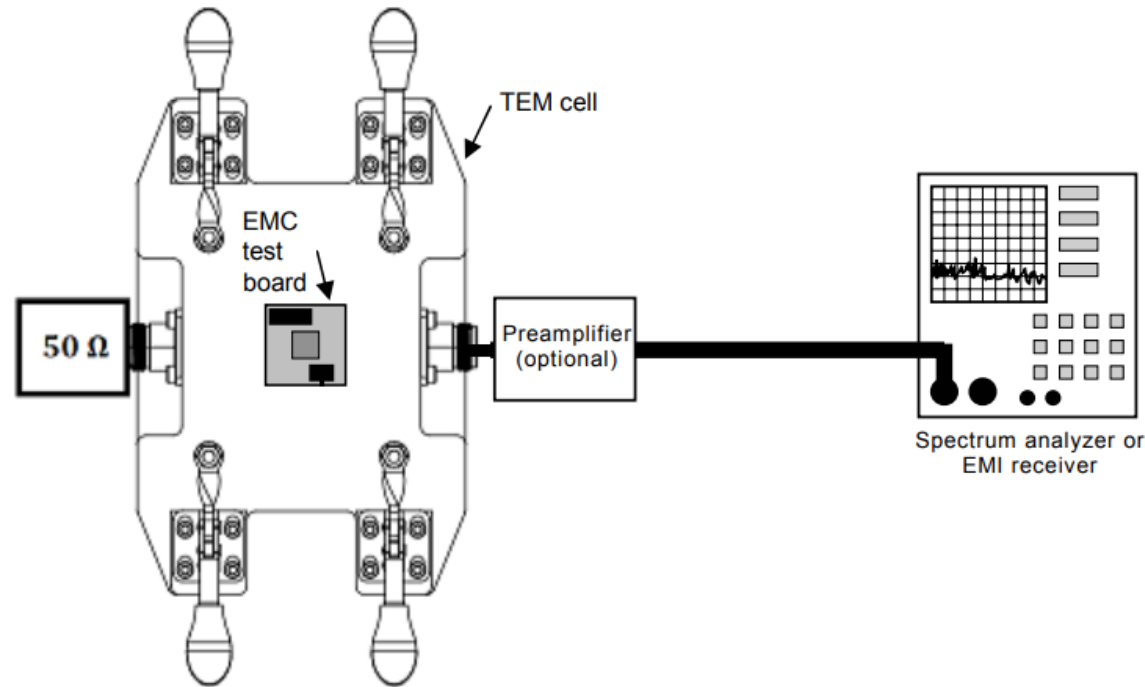
- TEM Cell Overview:
 - Transverse-electromagnetic-mode (TEM) is an electromagnetic field pattern of radiation where both E and H fields are perpendicular to the direction of the radiation propagation
 - A TEM Cell is an expanded coaxial transmission line (septum) that propagates TEM waves (within a cavity)
 - E and H field are approximately uniform between the septum and cavity ceiling
 - Approximately simulates a planar field in free space (377Ω far-field wave impedance)
 - E field strength at the mid-point between the septum and cavity ceiling is related to the RF voltage between septum and cavity GND, and the septum to cavity ceiling height
- SAE J1752-3 Standard:
 - The SAE J1752-3 standard defines a method for measuring EM radiation of an integrated circuit (IC) using a TEM Cell
- ESD/EMC TEM Cell Products:
 - Specially designed to satisfy the requirements of the following standards:
 - SAE J1752-3
 - IEC 61967-8
 - IEC 61967-2
 - Software solution is available for J1752-3 compliant RE testing and emissions level classification

SAE J1752-3 Test System



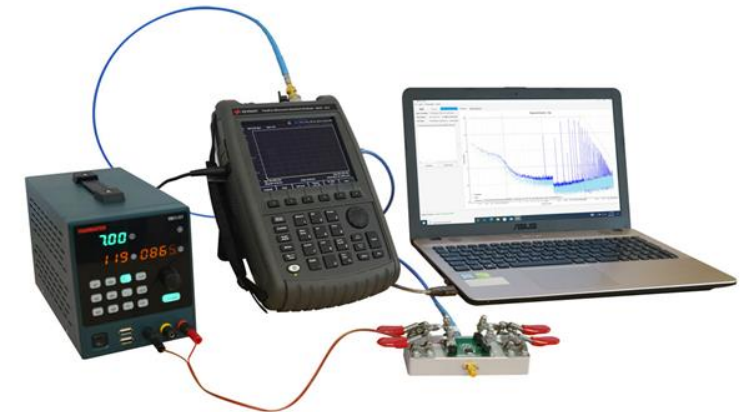
SAE J1752-3 Test Conditions

- IC device-under-test (DUT) is mounted to a test board
- DUT test board is mated to the ceiling of the TEM cell cavity, acting as a TEM Cell wall
- DUT shall be powered-on in an operating mode specified by the manufacturer
- The test frequency range is determined by the TEM Cell in use



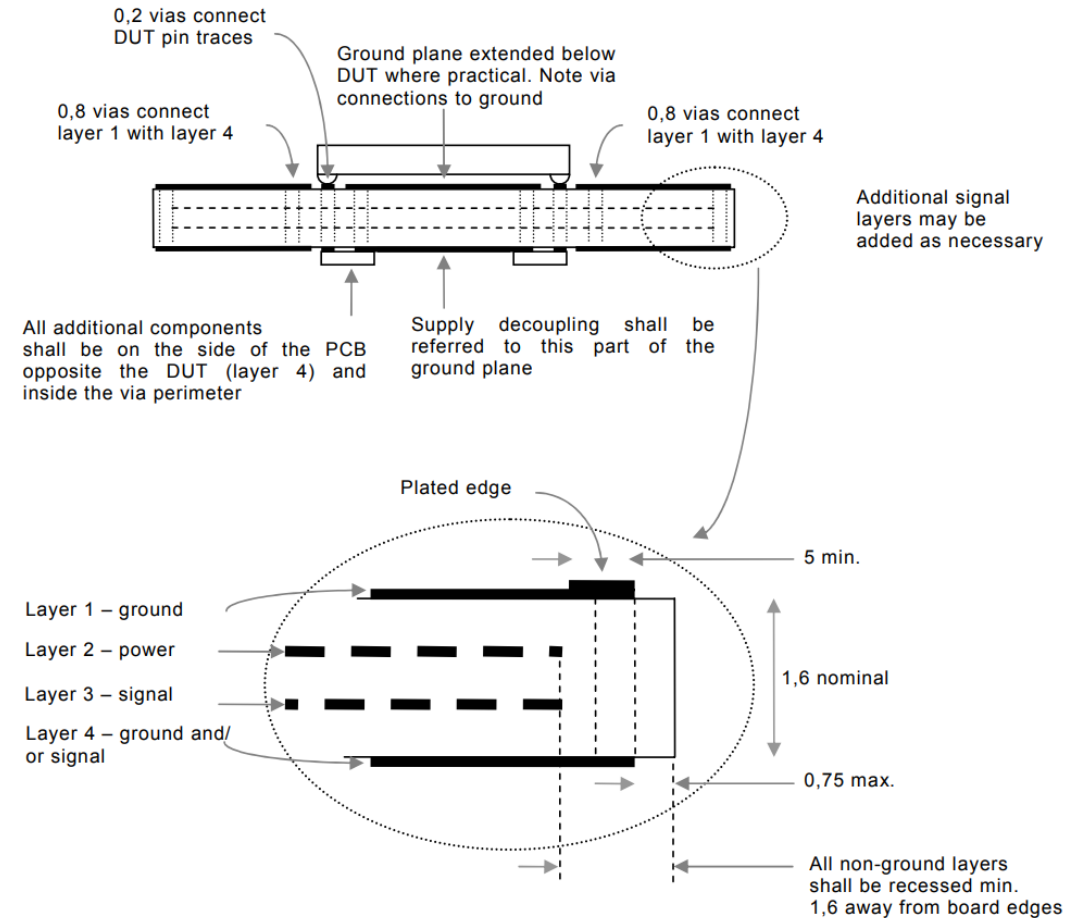
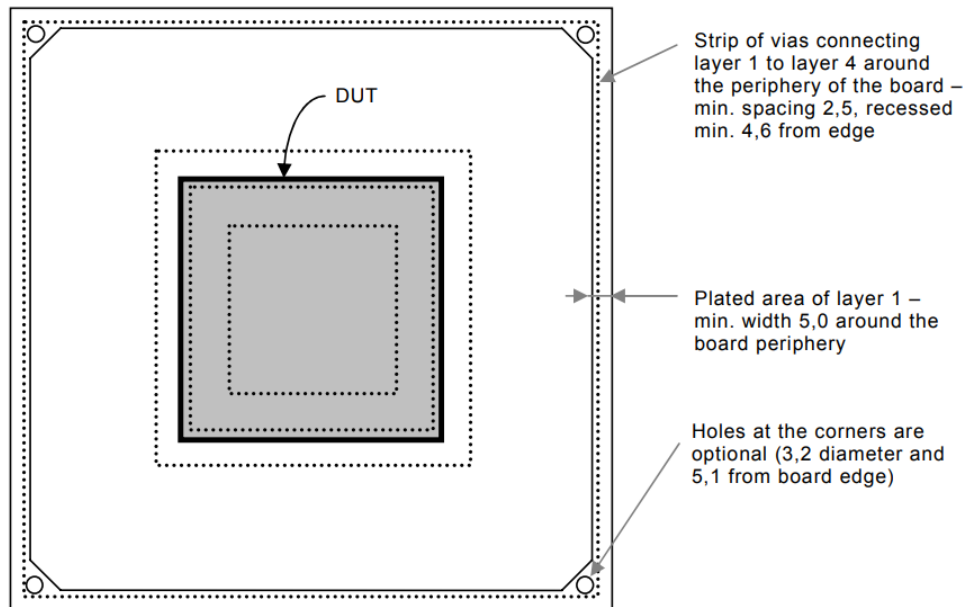
Test Setup

- System Gain:
 - Double-shielded or semi-rigid coaxial cable is required
 - A low-noise preamplifier of 20 to 30 dB nominal gain is typically used
 - Gain accuracy of ± 0.5 dB is required
 - Gain magnitude shall remain within a 6 dB envelope of full frequency range
- RF Measurement Settings:
 - Frequency: 150 kHz – 8 GHz
 - RBW: 9 kHz or 10 kHz
 - VBW: $3 \times \text{RBW}$
 - Detector Type: Peak
 - Sweep Mode: Max Hold
- TEM Cell
 - Port opposite of measurement shall be terminated with $50\ \Omega$ load ($\text{VSWR} < 1.1$)
 - PCB test board properly mated to cell the TEM Cell cavity
 - $\text{VSWR} < 1.4$
 - Septum Width $> .91 \times \text{DUT package width}$
 - Septum-to-Wall Height $< 2 \times \text{DUT package height}$



Test Setup Continued

- DUT Test Board PCB:
 - Clear description of PCB layout design requirements (J1752-3 Section 6.2):



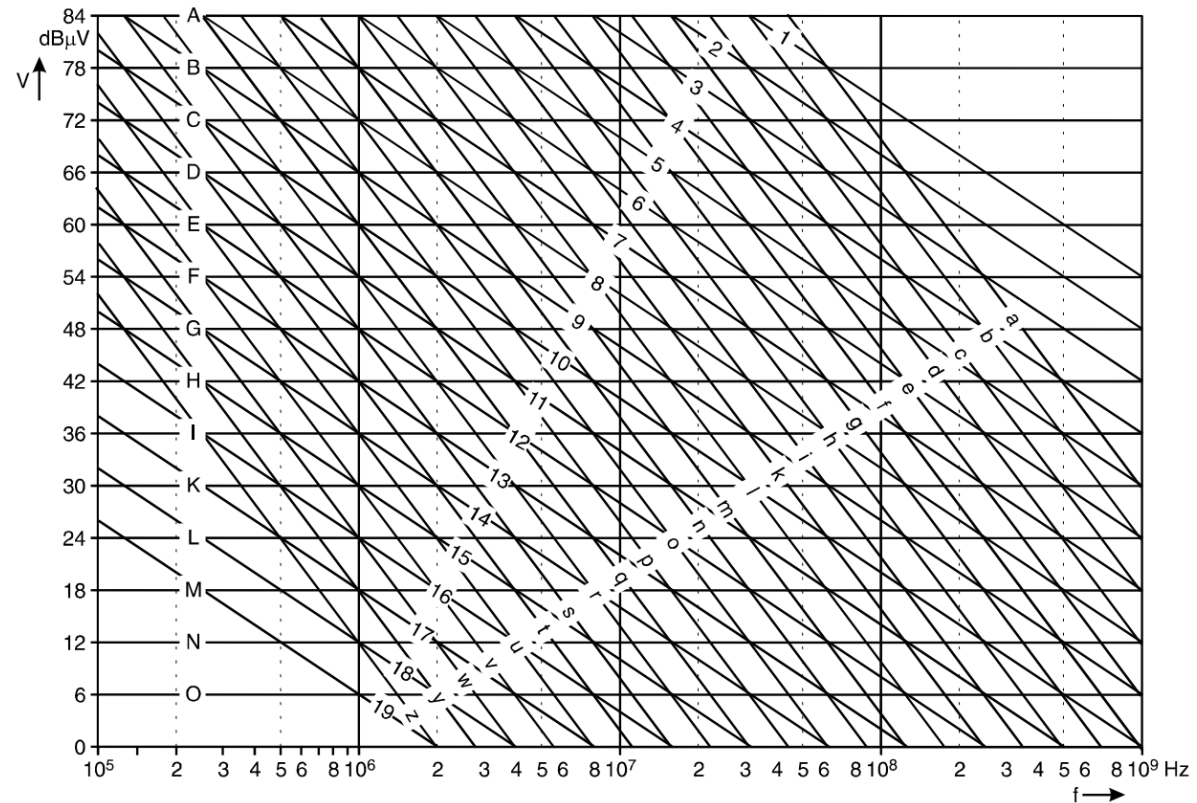
Procedure

- Ambient Measurement
 - Measured ambient levels shall be 6 dB below the target reference level
 - Emissions measurement results are only considered reliable when at least 6 dB above the noise floor
 - If necessary, tests shall be conducted within a shielded chamber
- DUT Operational Check
 - With the IC test board energized, complete an operational check to verify the proper function of the device and the IC test mode software
- DUT Measurement
 - Operational check to verify proper DUT test mode
 - While DUT is in test mode, measure RF emissions accumulating 3 sweeps on max hold
 - Individual sweep time should be greater than the full length of a test mode software loop cycle
 - Two measurements shall be taken:
 - 0° PCB position
 - 90° PCB position

Results Presentation

- Emissions Classifications

- The classification describes the maximum measured emission level
- Two letters and one number are used
- Characters represent one of three separate slopes
 - 0 dB / decade slope: 'A' - 'O'
 - -20 dB / decade slope: '1' - '19'
 - -40 dB / decade slope: 'a' - 'z'



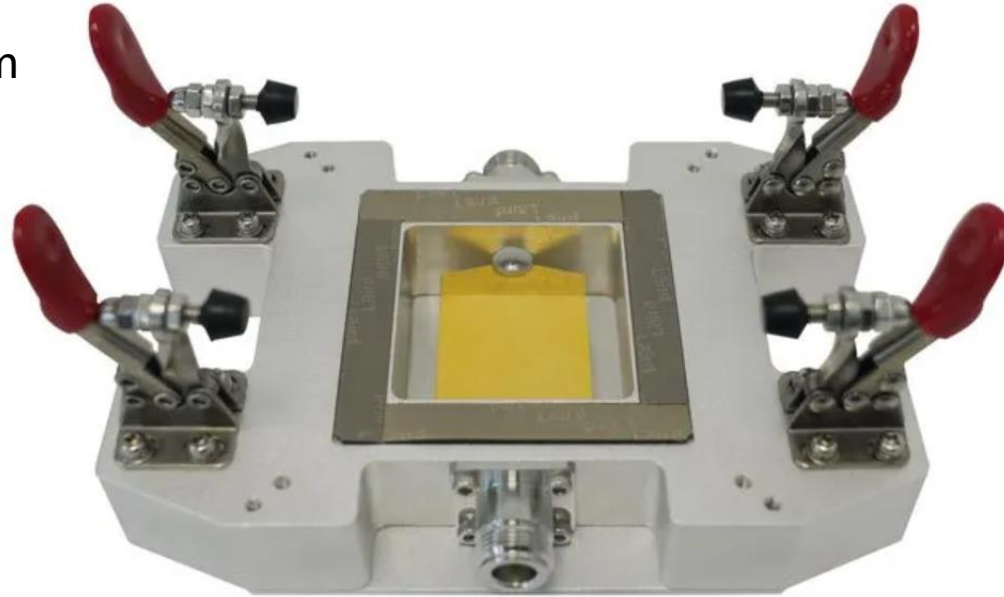
ESDEMC TEM Cell Products & Solutions

- All ESDEMC TEM Cells may be used for SAE J1752-3 testing

TEM Cell Model	Insertion Loss (1dB Bandwidth)	VSWR	Max DUT Width	Max DUT Height	Max CW Input Power	Max CW Input Voltage	RF Connector Type
EM601-6	DC-6GHz	< 1.5	37.5mm	6.2mm	57dBm	44dBV	Type-N
EM601-6a	DC-6GHz	< 1.4	37.5mm	6.2mm	57dBm	44dBV	Type-N
EM601-8	DC-8GHz	< 1.4	24.0mm	4.0mm	53dBm	40dBV	SMA
EM602-10	DC-10GHz	< 1.5	37.5mm	0.8mm	48dBm	35dBV	SMA
EM603-8	DC-8GHz	< 1.4	24.0mm	4.0mm	53dBm	40dBV	SMA
EM603-10	DC-10GHz	< 1.5	18.9mm	3.2mm	53dBm	40dBV	SMA
EM603-12	DC-12GHz	< 1.5	15.1mm	2.5mm	53dBm	40dBV	SMA
EM603-14	DC-14GHz	< 1.5	12.2mm	2.0mm	53dBm	40dBV	SMA

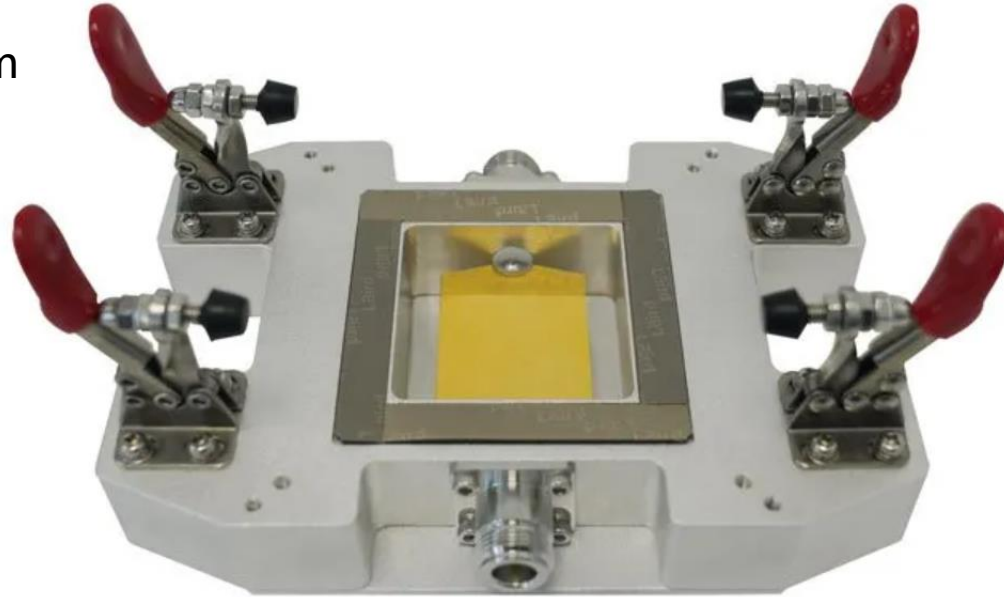
ESDEMC TEM Cell Products & Solutions

- EM601-6:
 - Frequency Range: 150 kHz – 6 GHz
 - Septum-to-Wall Height: 12.5mm
 - Septum Width: 34mm
 - VSWR: < 1.5
 - Max Input Power: 57dBm



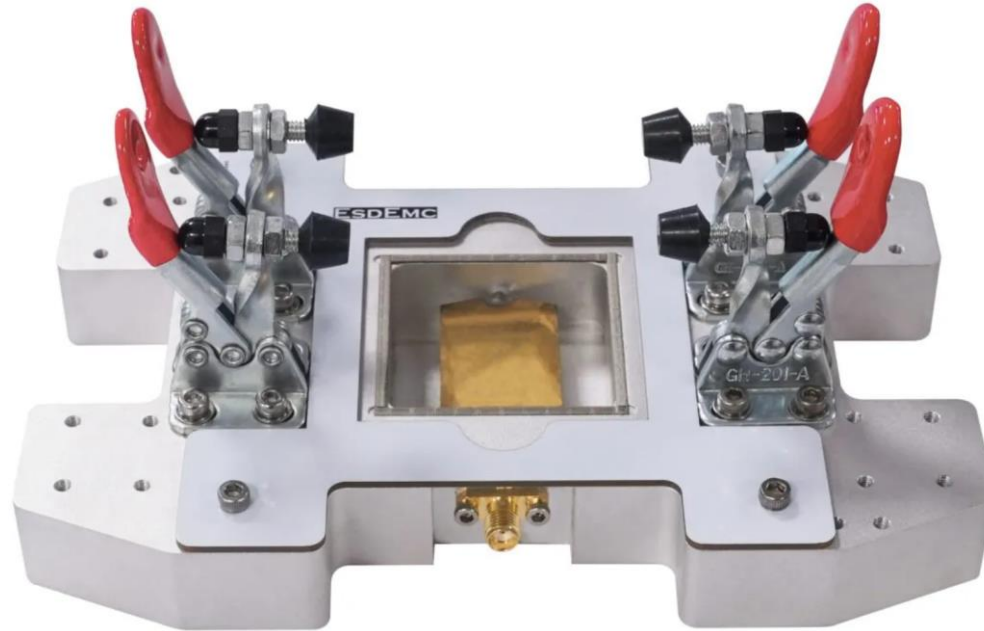
ESDEMC TEM Cell Products & Solutions

- EM601-6a:
 - Frequency Range: 150 kHz – 6 GHz
 - Septum-to-Wall Height: 12.5mm
 - Septum Width: 34mm
 - VSWR: < 1.4
 - Max Input Power: 57dBm



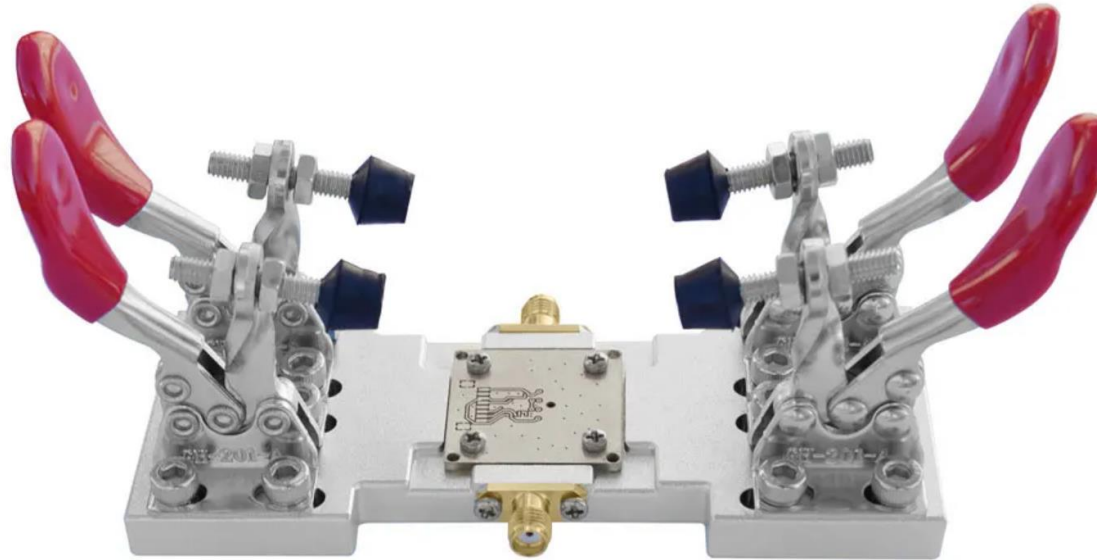
ESDEMC TEM Cell Products & Solutions

- EM601-8:
 - Frequency Range: 150 kHz – 8 GHz
 - Septum-to-Wall Height: 8mm
 - Septum Width: 22mm
 - VSWR: < 1.4
 - Max Input Power: 53dBm



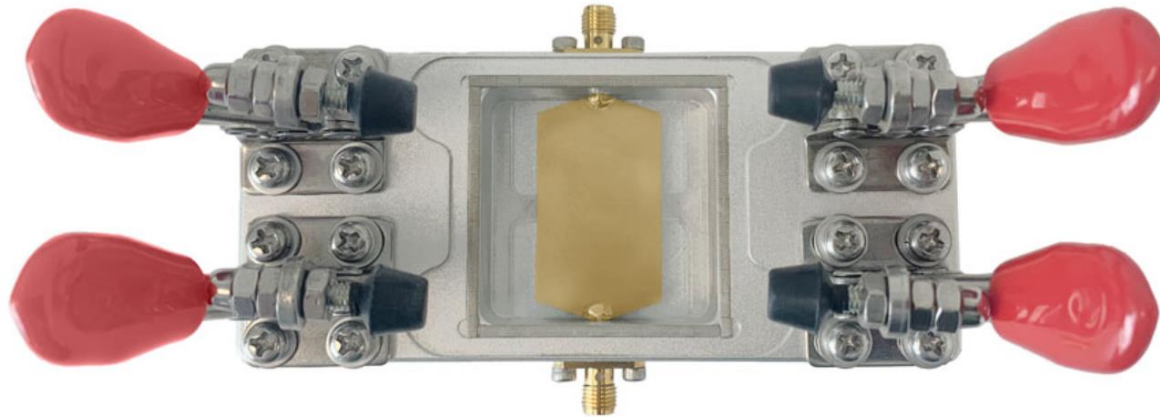
ESDEMC TEM Cell Products & Solutions

- EM602-10:
 - Frequency Range: 150 kHz – 8 GHz
 - Septum-to-Wall Height: 8mm
 - Septum Width: 22mm
 - VSWR: < 1.5
 - Max Input Power: 48dBm



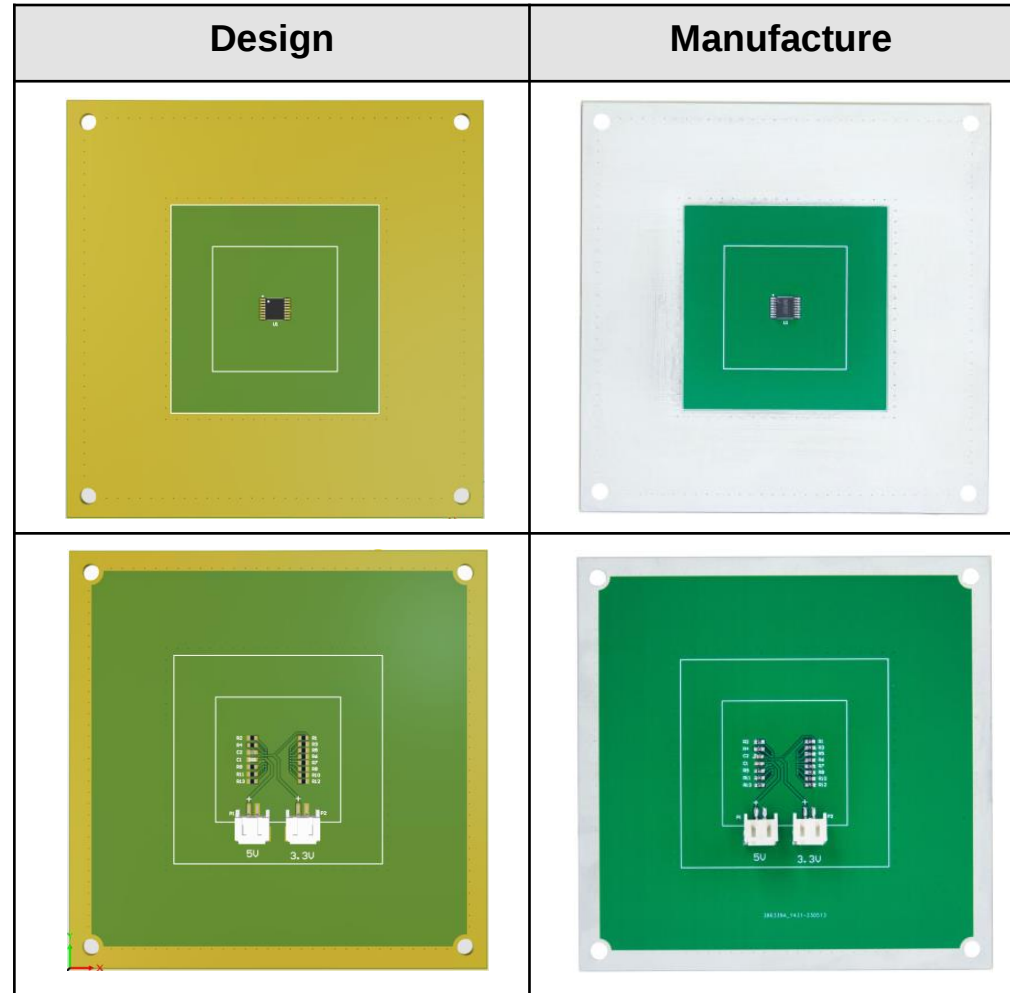
ESDEMC TEM Cell Products & Solutions

- EM603-8:
 - Frequency Range: 150 kHz – 8 GHz
 - Septum-to-Wall Height: 8mm
 - Septum Width: 22mm
 - VSWR: < 1.4
 - Max Input Power: 53dBm



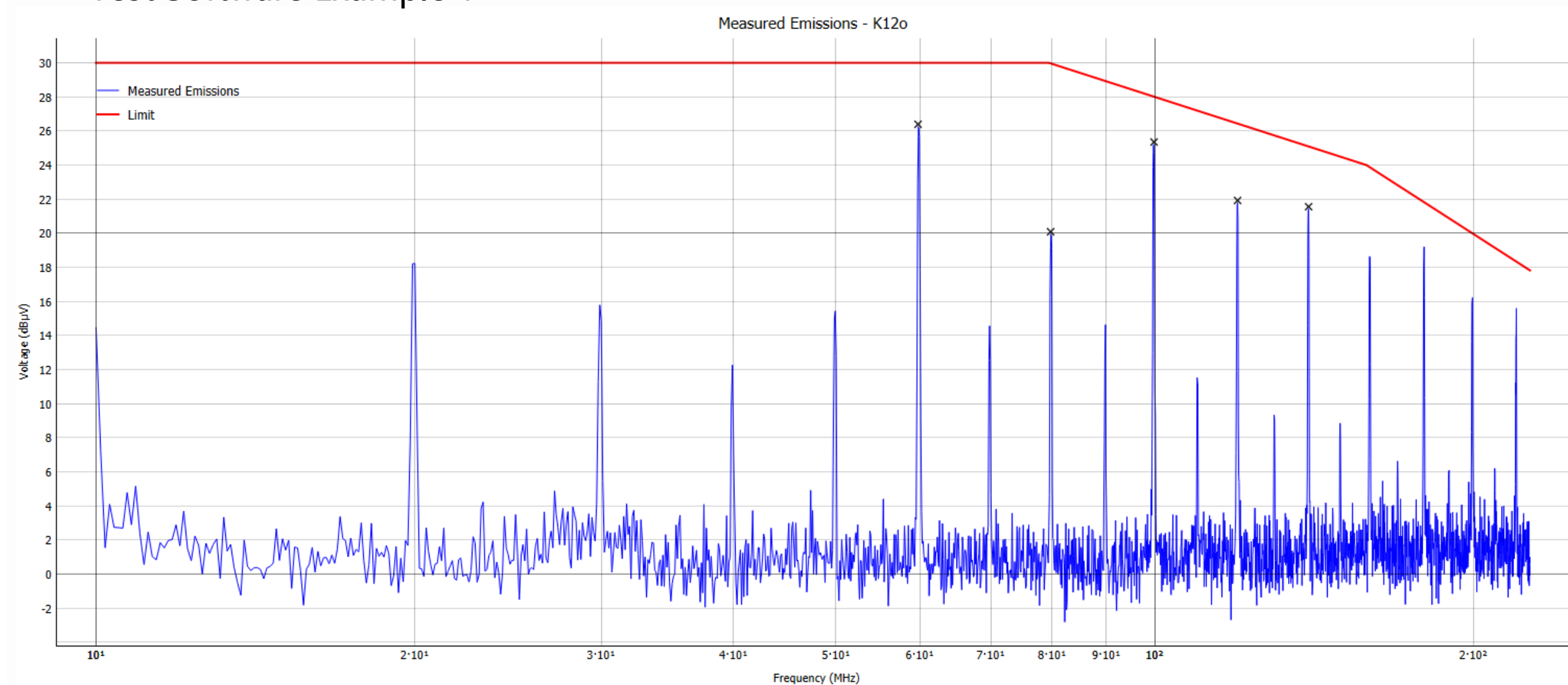
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- IC Test Board Layout Solutions



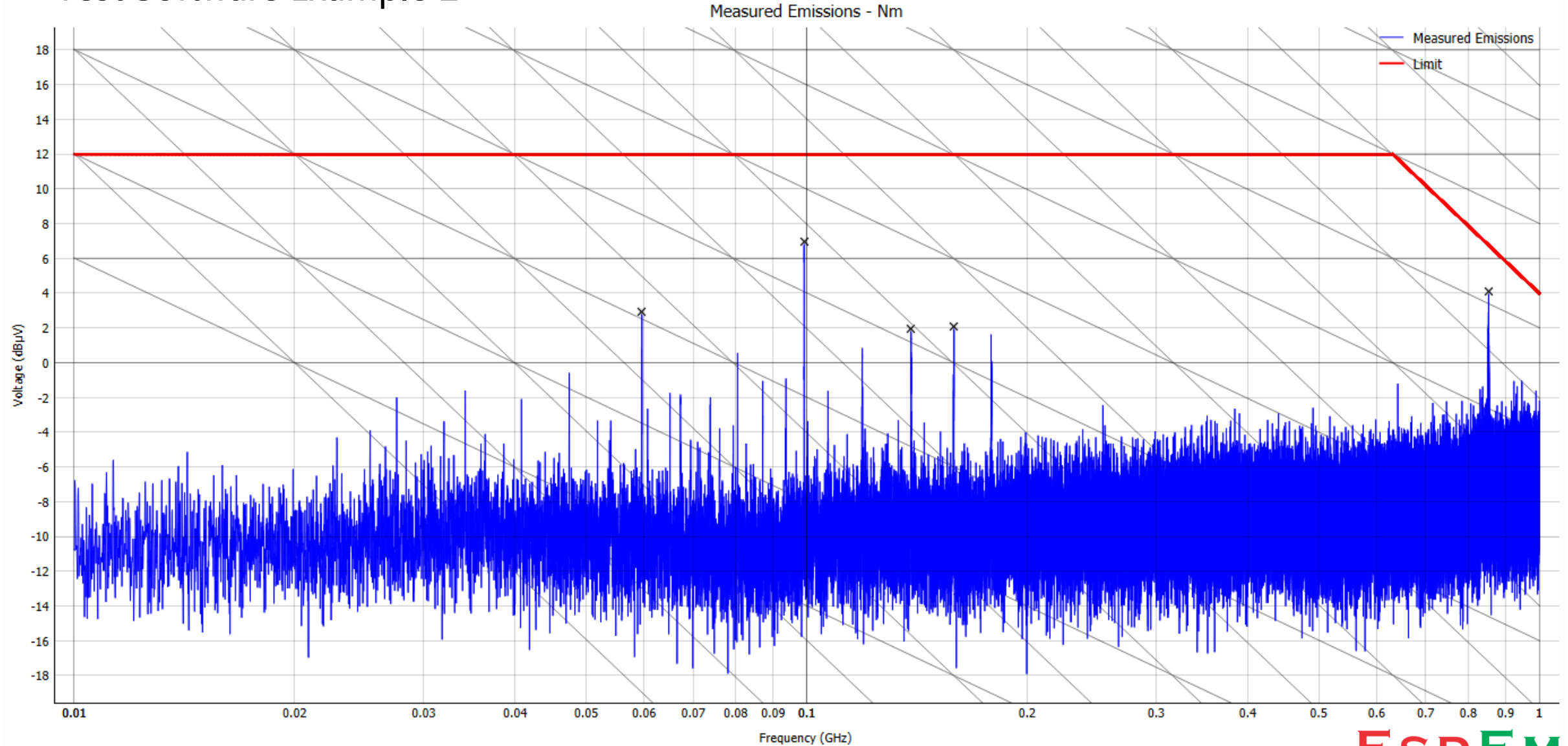
ESDEMC TEM Cell Products & Solutions

- Test Software Example 1



ESDEMC TEM Cell Products & Solutions

- Test Software Example 2



ESDEMC TEM Cell Products & Solutions

- Test Software Example 3

